2SK0601 (2SK601)

Silicon N-channel MOSFET

For switching

■ Features

- Low on-resistance R_{DS(on)}
- High-speed switching
- Allowing to be driven directly by CMOS and TTL
- Mini-power type package, allowing downsizing of the sets and automatic insertion through the tape/magazine packing.

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Drain to source voltage	V_{DS}	80	V
Gate to source voltage	V_{GSO}	20	V
Drain current	I_D	±0.5	A
Max drain current	I_{DP}	±1	A
Allowable power dissipation *	P_{D}	1	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Note) *: PC board: Copper foil of the drain portion should have a area of $1\ cm^2$ or more and the board thickness should be 1.7 mm.

Unit: mm 4.5±0.1 1.6±0.2 1.5±0.1 0.4±0.08 1.5±0.1 1

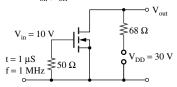
Marking Symbol: O

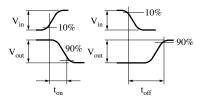
■ Electrical Characteristics $T_a = 25$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain to source cut-off current	I_{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0$			10	μΑ
Gate to source leakage current	I_{GSS}	$V_{GS} = 20 \text{ V}, V_{DS} = 0$			0.1	μΑ
Drain to source breakdown voltage	V _{DSS}	$I_{DS} = 100 \ \mu A, \ V_{GS} = 0$	80			V
Gate threshold voltage	V _{th}	$I_D = 1 \text{ mA}, V_{DS} = V_{GS}$	1.5		3.5	V
Drain to source on-resistance *1	R _{DS(on)}	$I_D = 0.5 \text{ A}, V_{GS} = 10 \text{ V}$		2	4	Ω
Forward transfer admittance	Y _{fs}	$I_D = 0.2 \text{ A}, V_{DS} = 15 \text{ V}, f = 1 \text{ kHz}$		300		mS
Input capacitance (common source)	C _{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		45		pF
Output capacitance (common source)	C _{oss}			30		pF
Reverse transfer capacitance (common source)	C_{rss}			8		pF
Turn-on time *2	t _{on}			15		ns
Turn-off time *2	t _{off}			20		ns

Note) *1: Pulse measurement

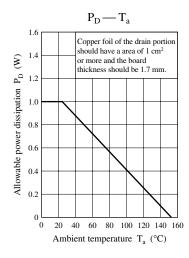
 $*2: t_{on}$, t_{off} measurement circuit

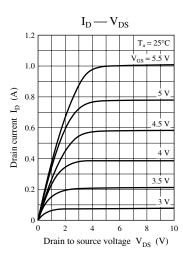


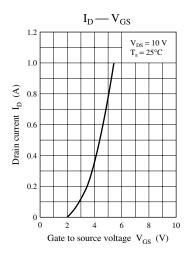


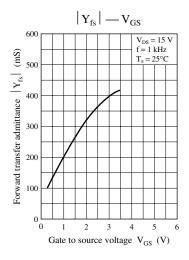
Note) The part number in the parenthesis shows conventional part number.

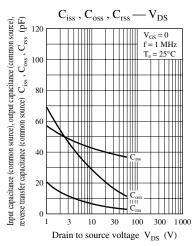
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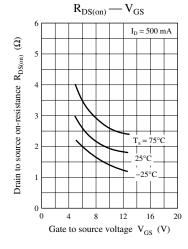


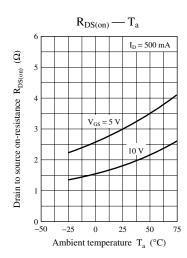












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